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Date:

May 26, 2004

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applic. No.

: 10/002,925

Confirmation No. 5108

Applicant

: Andreas Kux et al.

Filed

: November 2, 2001

TC/A.U.

: 2813

Examiner

: Nema O. Berezny

Title:

: Method and Device for Securing a Multi-

Dimensionally Constructed Chip Stack and Chip

Configuration

Docket No.

: 1999P1778

Customer No. : 24131

Hon. Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

## **AMENDMENT**

## Sir:

In response to the Office action dated March 2, 2004, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 11 of this paper.